

R6020ANX

Nch 600V 20A Power MOSFET

Datasheet

V _{DSS}	600V
R _{DS(on)} (Max.)	0.22Ω
Ι _D	±20A
P _D	85W

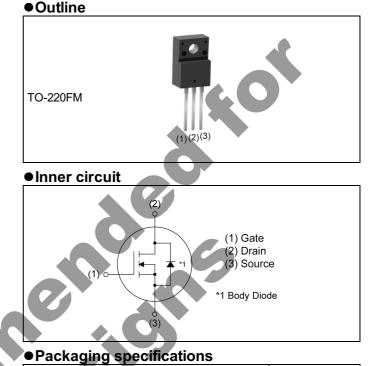
Features

- 1) Low on-resistance.
- 2) Fast switching speed.
- 3) Gate-source voltage (V_{GSS}) guaranteed to be ±30V.
- 4) Drive circuits can be simple.
- 5) Parallel use is easy.

Switching Power Supply

Application

6) Pb-free lead plating ; RoHS compliant



	Packing	Bulk
	Reel size (mm)	-
	Tape width (mm)	-
Туре	Basic ordering unit (pcs)	500
	Taping code	-
	Marking	R6020ANX

• Absolute maximum ratings (T_a = 25°C , unless otherwise specified)

Parameter		Symbol	Value	Unit
Drain - Source voltage		V _{DSS}	600	V
	$T_{\rm C} = 25^{\circ}{\rm C}$	I _D *1	±20	А
Continuous drain current	T _C = 100°C	I _D *1	±9.7	А
Pulsed drain current		ا _{DP} *2	±80	А
Gate - Source voltage		V _{GSS}	±30	V
Avalanche current, single pulse		I_{AS}^{*3}	10	А
Avalanche energy, single pulse		E _{AS} *3	26.7	mJ
Avalanche energy, repetitive		E _{AR} *4	3.5	mJ
Power dissipation $(T_c = 25^{\circ}C)$		PD	85	W
Junction temperature		Tj	150	°C
Operating junction and storage ter	T _{stg}	-55 to +150	°C	
Reverse diode dv/dt		dv/dt	15	V/ns

•Absolute maximum ratings

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Parameter		S	ymbol	C	ondition	S	Values	Unit
Drain - Source voltage slope		(dv/dt	V _{DS} = 4 T _j = 125	80V, I _D 5℃	= 20A	50	V/ns
●Thermal resistance								
Paramete	er		Syn	nbol	Min.	Values Typ.	Max.	Unit
Thermal resistance, junction - c	case		Rt	ŋJC	- (-	1.47	°C/W
Thermal resistance, junction - a	ambient		Rt	hJA		-	70	°C/W
Soldering temperature, waveso	oldering for 10s		Ts	old	<u> </u>	-	265	°C
•Electrical characteristics ($T_a = 25^{\circ}C$)								
Parameter	Symbol	C	Conditions	3	2	Values		Unit
					Min.	Тур.	Max.	
Drain - Source breakdown		- 01			<u> </u>			V

Parameter	Symbol	Symbol Conditions		Values		Unit
	Symbol	Conditions	Min.	Тур.	Max.	Ofile
Drain - Source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 1mA	600	-	-	V
Drain - Source avalanche breakdown voltage	V _{(BR)DS}	V _{GS} = 0V, I _D = 20A	-	700	-	V
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 600V, V_{GS} = 0V$ $T_j = 25^{\circ}C$ $T_j = 125^{\circ}C$	-	0.1	100 1000	μA
Gate - Source leakage current	I _{GSS}	V_{GS} = ±30V, V_{DS} = 0V	-	-	±100	nA
Gate threshold voltage	V _{GS(th)}	V _{DS} = 10V, I _D = 1mA	2.5	-	4.5	V
Static drain - source on - state resistance	R _{DS(on)} *6	$V_{GS} = 10V, I_D = 10A$ $T_j = 25^{\circ}C$ $T_j = 125^{\circ}C$	-	0.17 0.36	0.22	Ω
Gate resistance	R _G	f = 1MHz, open drain	-	13.8	-	Ω

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•Electrical characteristics (T_a = 25°C)

Deremeter	Cumphal	Conditions	Values			Linit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Transfer Admittance	Y _{fs} ⁵6	V _{DS} = 10V, I _D = 10A	7	14	_	S
Input capacitance	C _{iss}	V _{GS} = 0V	-	2040		
Output capacitance	C _{oss}	V _{DS} = 25V	-	1660		pF
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	70	-	
Effective output capacitance, energy related	C _{o(er)}	V _{GS} = 0V,		69.8	-	
Effective output capacitance, time related	C _{o(tr)}	V _{DS} = 0V to 480V	-	260	-	pF
Turn - on delay time	t _{d(on)} *6	$V_{DD} \simeq 300 V, V_{GS} = 10 V$	-	40	-	
Rise time	t _r *6	I _D = 10A		60	-	
Turn - off delay time	t _{d(off)} *6	R _L ≃ 30Ω		230	460	ns
Fall time	t _f *6	R _G = 10Ω		70	140	

• Gate charge characteristics (T_a = 25°C

Parameter Symbol Conditions		Values		
Parameter Symbol Conditions	Min.	Тур.	Max.	Unit
Total gate charge Q_g^{*6} $V_{DD} \simeq 300V$	-	65	-	
Gate - Source charge Q_{gs}^{*6} $I_D = 20A$	-	10	-	nC
Gate - Drain charge Q_{gd}^{*6} $V_{GS} = 10V$	-	25	-	
Gate plateau voltage $V_{(plateau)}$ $V_{DD} \simeq 300V$, $I_D = 20J$	A -	6	-	V

*1 Limited only by maximum temperature allowed.

*2 Pw \leq 10µs, Duty cycle \leq 1%

*3 L \simeq 500µH, V_{DD} = 50V, R_G = 25 Ω , starting T_j = 25°C

- *4 L \simeq 500µH, V_{DD} = 50V, R_G = 25 Ω , starting T_j = 25°C, f = 10kHz
- *5 Reference measurement circuits Fig.5-1.

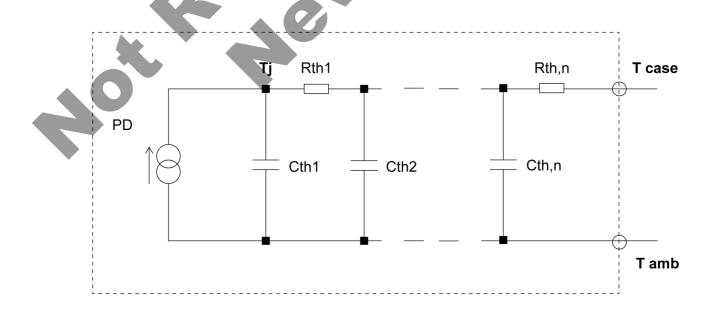
*6 Pulsed

•Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Continuous forward current	۱ _S *1	T - 25°0	-	-	20	А
Pulse forward current	ا _{SP} *2	T _C = 25°C	-	-	80	A
Forward voltage	V_{SD}^{*6}	V _{GS} = 0V, I _S = 10A	-	-	1.5	V
Reverse recovery time	t _{rr} *6		-	486	-	ns
Reverse recovery charge	Q _{rr} *6	I _S = 20A di/dt = 100A/µs		7.8	-	μC
Peak reverse recovery current	^{*6}			32	-	А
Peak rate of fall of reverse recovery current	di _{rr} /dt	T _j = 25°C) -	800	-	A/µs

• Typical transient thermal characteristics

Symbol	Value	Unit	Symbol	Value	Unit
R _{th1}	0.0789		C _{th1}	0.00458	
R _{th2}	0.579	к/w	C _{th2}	0.0603	Ws/K
R _{th3}	2.17		C _{th3}	0.549	







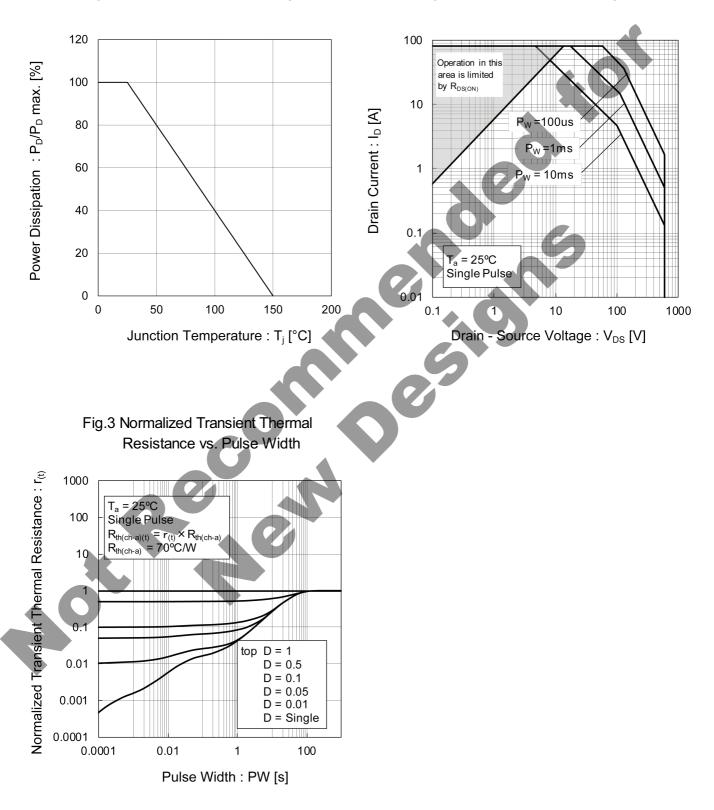


Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area



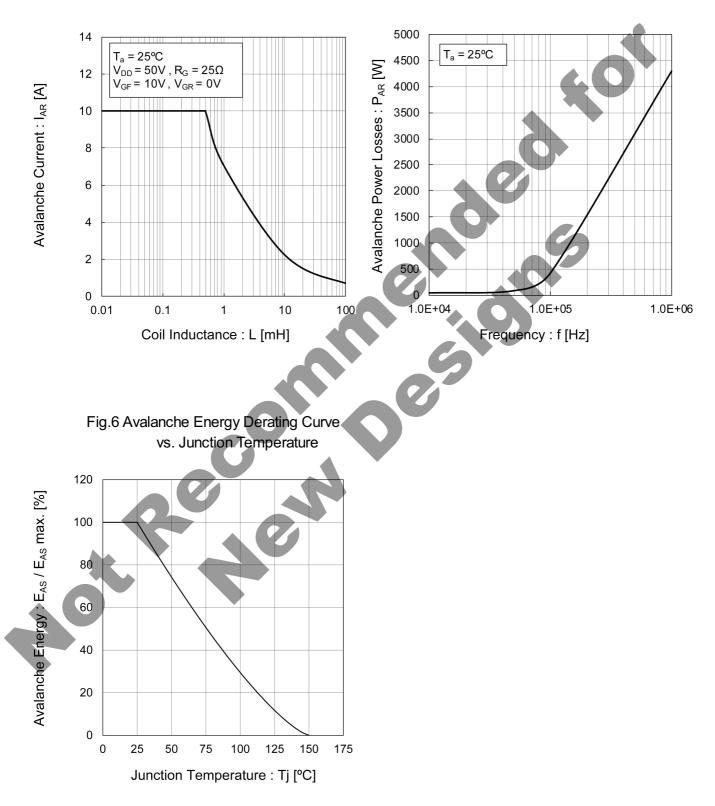


Fig.4 Avalanche Current vs. Inductive Load

Fig.5 Avalanche Power Losses



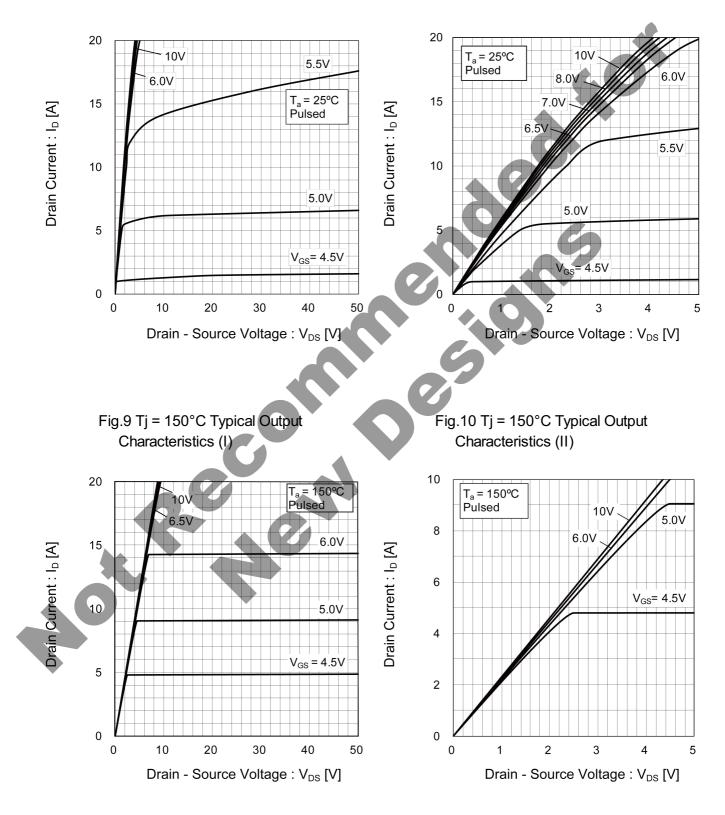


Fig.7 Typical Output Characteristics(I)

Fig.8 Typical Output Characteristics(II)



Fig.12 Typical Transfer Characteristics

• Electrical characteristic curves

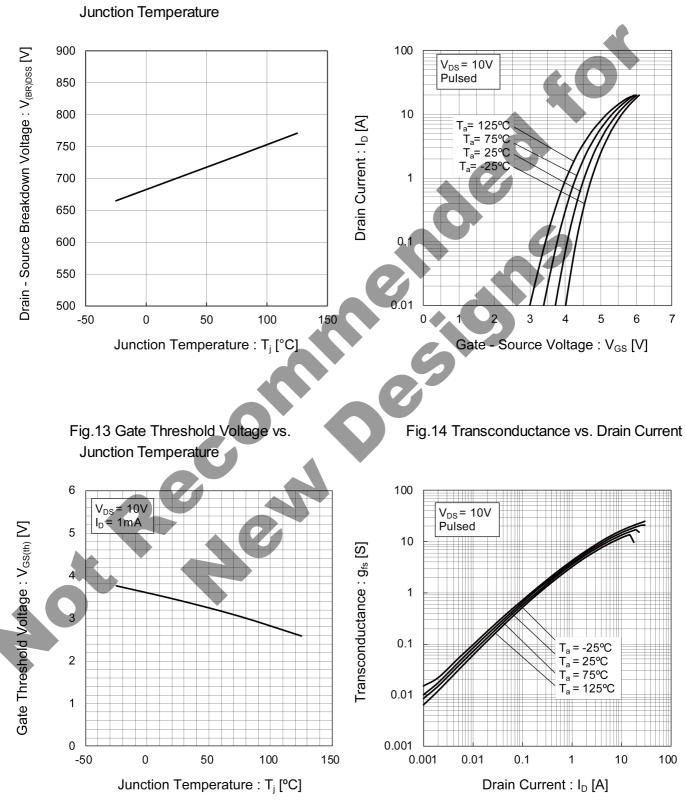
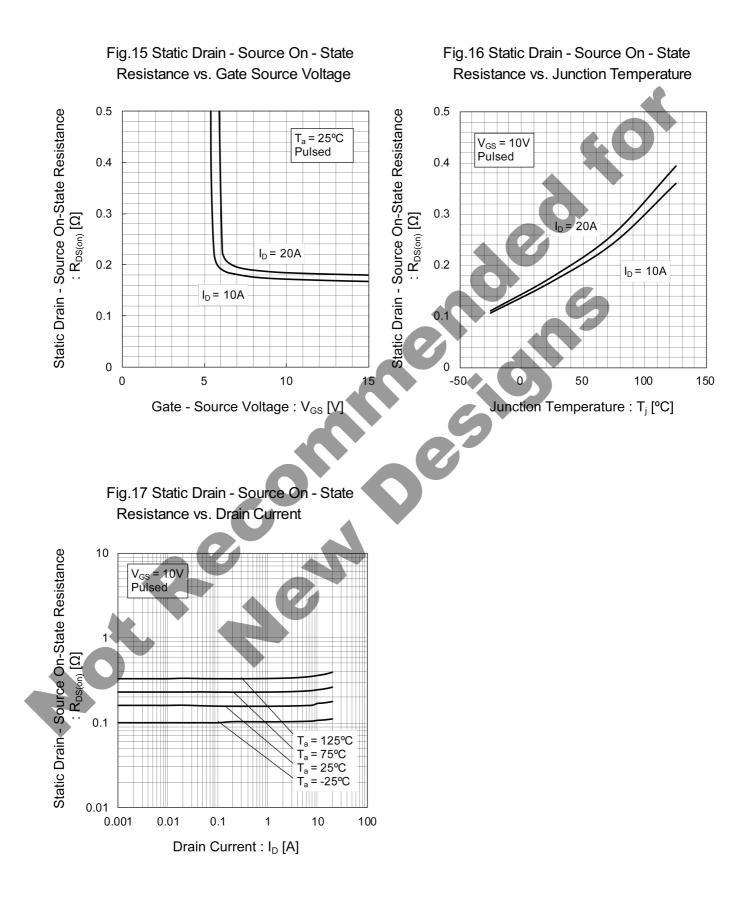


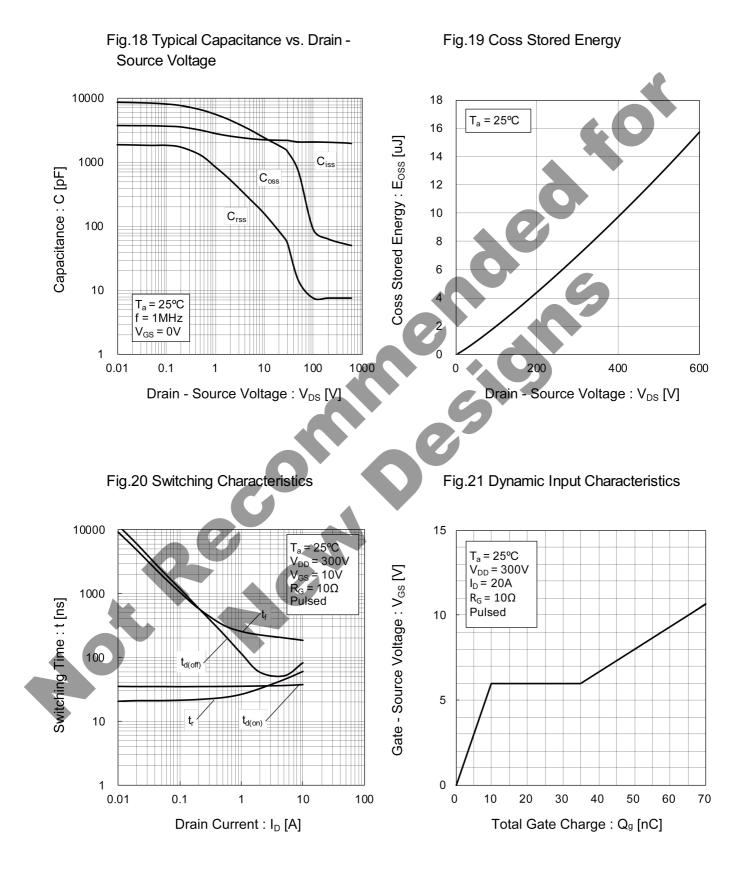
Fig.11 Breakdown Voltage vs. Junction Temperature



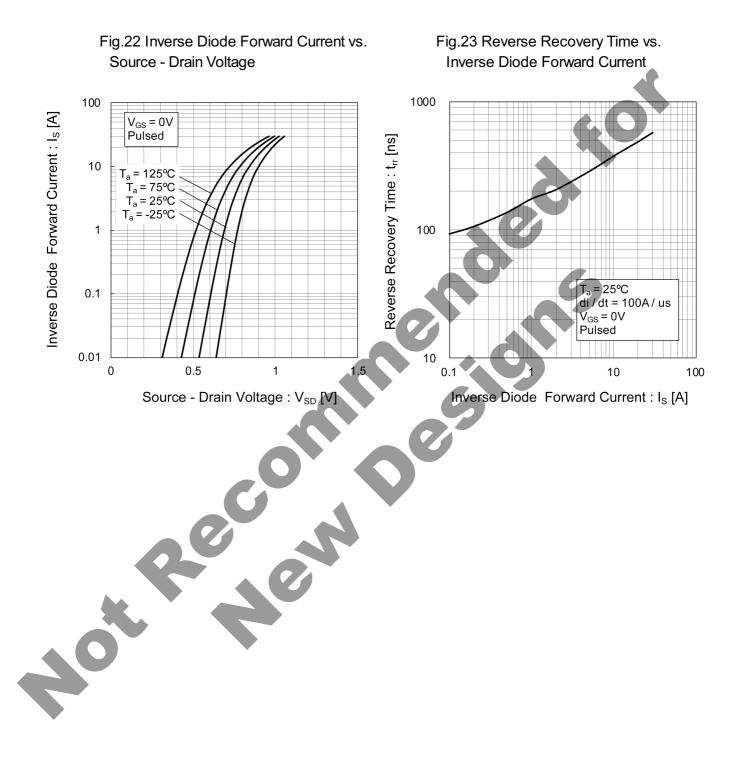








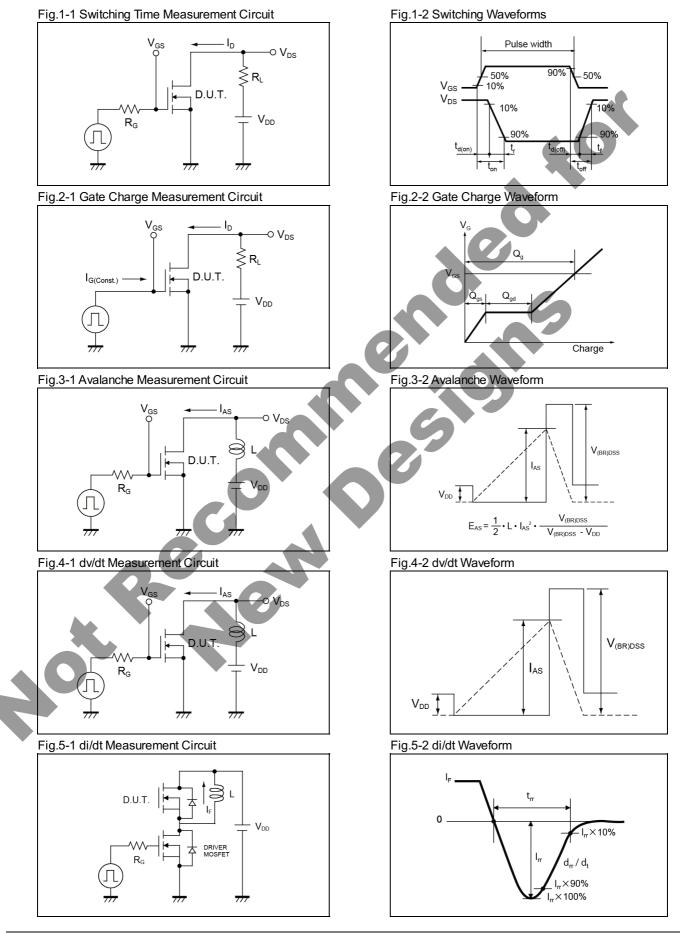








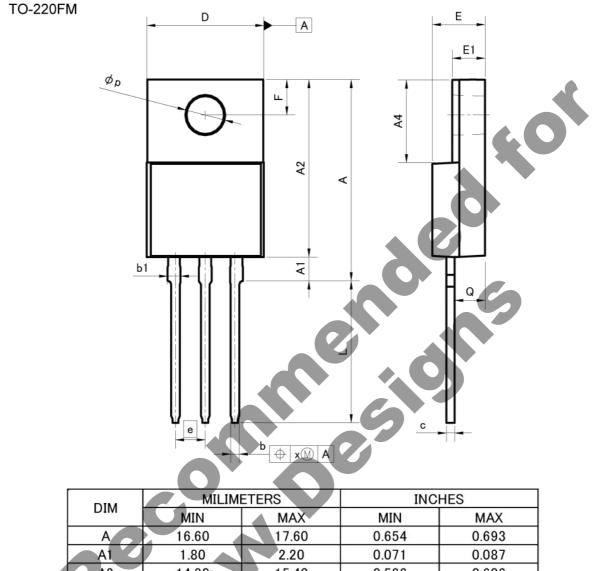
Measurement circuits





ROHM

Dimensions





		10.00	17.00	0.001	0.000
	A1	1.80	2.20	0.071	0.087
	A2	14.80	15.40	0.583	0.606
	A4	6.80	7.20	0.268	0.283
	þ	0.70	0.90	0.028	0.035
\sim	b1	1.10	1.50	0.043	0.059
	с	0.70	0.85	0.028	0.033
	D	9.90	10.30	0.390	0.406
	E	4.40	4.80	0.173	0.189
	е	2.	54	0.1	00
	E1	2.70	3.00	0.106	0.118
	F	2.80	3.20	0.110	0.126
	L	11.50	12.50	0.453	0.492
	р	3.00	3.40	0.118	0.134
	Q	2.10	3.10	0.083	0.122
	х	_	0.38		0.015

Dimension in mm/inches



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(Note1) Medical E	e1) Medical Equipment Classification of the Specific Applications					
JAPAN	USA	EU	CHINA			

JAPAN	USA	EU	CHINA
CLASSⅢ		CLASS II b	CLASSI
CLASSⅣ	CLASSII	CLASSⅢ	CLASSI

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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power, exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.

De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.

- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

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